

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10798540			
<b>Filing Date:</b>	10-Mar-2004			
<b>Title of Invention:</b>	ATTACHMENT OF INTEGRATED CIRCUIT STRUCTURES AND OTHER SUBSTRATES TO SUBSTRATES WITH VIAS			
<b>First Named Inventor/Applicant Name:</b>	Sergey Savastliouk			
<b>Filer:</b>	Michael Shenker/Jeannie Ha			
<b>Attorney Docket Number:</b>	M-15302-1P US			
Filed as Large Entity				
<b>Utility      Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Utility Appt Issue fee	1501	1	1400	1400
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Extension-of-Time:</b>				
<b>Miscellaneous:</b>				
Printed copy of patent - no color	8001	1	3	3
<b>Total in USD (\$)</b>				<b>1703</b>